

AMENDMENTS**In The Claims:**

Please amend claims 43 and 56 to read as shown below. The changes made to claims 43 and 56 are detailed in the attached Appendix.

Sub
C1
B1
43. (Amended) A pre-cursor to a semiconductor device containing at least one area of sacrificial material made in accordance with a method comprising the steps of:

(A) forming a patterned layer of sacrificial material on a substrate corresponding to a pattern of one or more gaps to be formed in the semiconductor structure;

(B) depositing a second material on the substrate within regions bordered by the sacrificial material with the second material being formed with a height less than the height of the adjacent sacrificial material; and

(C) forming an overcoat layer of material overlying the patterned layer of sacrificial material and second material in the regions bordered by the sacrificial material,

whereby the height of the one or more areas of sacrificial material exceeds the height of the one or more areas of second material.

B2
Sub
C2
56. (Amended) A pre-cursor to a semiconductor comprising:
a substrate;

a patterned layer of conductive material on the substrate,

a patterned layer of sacrificial material on the substrate, the patterned layer of sacrificial material being greater in height than the patterned layer of conductive material; and

B2
cont.

an overcoat layer of a material overlying the patterned layer of conductive material and the patterned layer of sacrificial material.

In The Drawings:

Filed concurrently herewith is a Formal Request for Approval of Drawing Changes seeking the following corrections:

In Figure 5H, both occurrences of reference numeral 92 should be replace with reference numeral 94; and

In Figure 5I, both occurrences of reference numeral 92 should be replace with reference numeral 94.

REMARKS

Claims 43-57 will be pending in the application upon entry of the above amendments. Claims 43 and 56 have been amended for clarification purposes. Support for the amendments to claims 43 and 56 can be found in the specification and Figures as filed. Favorable reconsideration in light of the above amendments and the remarks which follow is respectfully requested.

I. Objection to the Drawings:

Figures 5H and 5I have been objected to under 37 C.F.R. § 1.84(p)(4) due to a duplicative reference numeral. As noted above, Figures 5H and 5I have been amended so as to correct this inadvertent error. Accordingly, this objection is believed to moot and withdrawal thereof is respectfully requested.